

L Number	Hits	Search Text	DB	Time stamp
-	4844	(electroplat\$3 plat\$3) near15 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) and semiconductor	USPAT; US-PGPUB; EPO; JPO	2003/12/04 11:05
-	1879	((electroplat\$3 plat\$3) near15 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) and semiconductor) and (electroplat\$3 plat\$3) near7 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) near7 (cu pd copper palladium)	USPAT; US-PGPUB; EPO; JPO	2003/12/04 11:08
-	875	((electroplat\$3 plat\$3) near15 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) and semiconductor) and (electroplat\$3 plat\$3) near7 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) near7 (cu pd copper palladium)) and (electroplat\$3 electrolyt\$6 near2 plat\$3) near5 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) near5 (cu pd copper palladium)	USPAT; US-PGPUB; EPO; JPO	2003/12/04 11:10
-	134	((((electroplat\$3 plat\$3) near15 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) and semiconductor) and (electroplat\$3 plat\$3) near7 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) near7 (cu pd copper palladium)) and (electroplat\$3 electrolyt\$6 near2 plat\$3) near5 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5) near5 (cu pd copper palladium)) and (enhanc\$3 improv\$3) near5 (seed\$4 nucle\$1 nucleat\$3 initiat\$3 cataly\$5)	USPAT; US-PGPUB; EPO; JPO	2003/12/04 11:12